



#9/B 2812  
7.2.03  
Mullish  
PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of

Jun-ichiro FURIHATA et al.

Group Art Unit: 2812

Application No.: 09/787,038

Examiner: C. LATTIN

Filed: March 13, 2001

Docket No.: 108868

For: METHOD OF PRODUCING A BONDED WAFER AND THE BONDED WAFER

AMENDMENT

In reply to the March 24, 2003, Office Action, the following is submitted:

**Amendments to the Claims** are reflected in the listing of claims; and

**Remarks.**

RECEIVED  
JUN 26 2003  
TECHNOLOGY CENTER 2800